

20 V, complementary Trench MOSFET Rev. 1 — 26 June 2012

Product data sheet

#### **Product profile** 1.

### **1.1 General description**

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in a small and leadless ultra thin DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

### 1.2 Features and benefits

- Very fast switching
- Trench MOSFET technology
- **1.3 Applications** 
  - Charging switch for portable devices
  - DC-to-DC converters
  - Small brushless DC motor drive

- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Exposed drain pad for excellent thermal conduction
- Power management in battery-driven portables
- Hard disc and computing power management

### 1.4 Quick reference data

Table 1.	Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-c	hannel), Static characteristic	S					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 3 A; T <sub>j</sub> = 25 °C		-	26	34	mΩ
TR2 (P-cl	nannel), Static characteristic	s					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -3.4 A; T <sub>j</sub> = 25 °C		-	55	70	mΩ
TR1 (N-c	hannel)						
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	20	V
V <sub>GS</sub>	gate-source voltage			-12	-	12	V
I <sub>D</sub>	drain current	$V_{GS}$ = 4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s	<u>[1]</u>	-	-	5.3	А

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Table 1.	Quick reference data continued						
Symbol	Parameter Conditions		Min	Тур	Max	Unit	
TR2 (P-ch	annel)						
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-20	V
$V_{GS}$	gate-source voltage			-12	-	12	V
I <sub>D</sub>	drain current	$V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s	<u>[1]</u>	-	-	-4.5	А

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

#### **Pinning information** 2.

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source TR1		54 50
2	G1	gate TR1	6 5 4	D1 D2
3	D2	drain TR2		
4	S2	source TR2	7 8	
5	G2	gate TR2		
6	D1	drain TR1	1 2 3	G1 S1 S2 G2
7	D1	drain TR1	Transparent top view	017aaa261
8	D2	drain TR2	DFN2020-6 (SOT1118)	

#### **Ordering information** 3.

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMCPB5530X	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1118			

#### Marking 4.

Table 4. Marking codes	
Type number	Marking code
PMCPB5530X	1W

#### **Limiting values** 5.

#### Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
TR1 (N-chan	nel)				
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C	-	20	V
V <sub>GS</sub>	gate-source voltage		-12	12	V

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#### Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
ID	drain current	$V_{GS} = 4.5 \text{ V}; \text{ T}_{amb} = 25 \text{ °C}; \text{ t} \le 5 \text{ s}$	<u>[1]</u>	-	5.3	А
		$V_{GS}$ = 4.5 V; $T_{amb}$ = 25 °C	<u>[1]</u>	-	4	А
		$V_{GS} = 4.5 \text{ V}; \text{ T}_{amb} = 100 ^{\circ}\text{C}$	<u>[1]</u>	-	2.6	А
I <sub>DM</sub>	peak drain current	$T_{amb} = 25 \text{ °C}$ ; single pulse; $t_p \le 10 \mu\text{s}$		-	12	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	490	mW
			<u>[1]</u>	-	1170	mW
		T <sub>sp</sub> = 25 °C		-	8330	mW
TR1 (N-cha	nnel), Source-drain diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	<u>[1]</u>	-	1.2	А
TR2 (P-cha	nnel)					
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-20	V
V <sub>GS</sub>	gate-source voltage			-12	12	V
I <sub>D</sub>	drain current	$V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C; t ≤ 5 s	<u>[1]</u>	-	-4.5	А
		$V_{GS}$ = -4.5 V; $T_{amb}$ = 25 °C	<u>[1]</u>	-	-3.4	А
		$V_{GS}$ = -4.5 V; $T_{amb}$ = 100 °C	<u>[1]</u>	-	-2.2	А
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-14	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	490	mW
			[1]	-	1170	mW
		T <sub>sp</sub> = 25 °C		-	8330	mW
TR2 (P-cha	nnel), Source-drain diode					
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	<u>[1]</u>	-	-1.2	А
Per device						
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

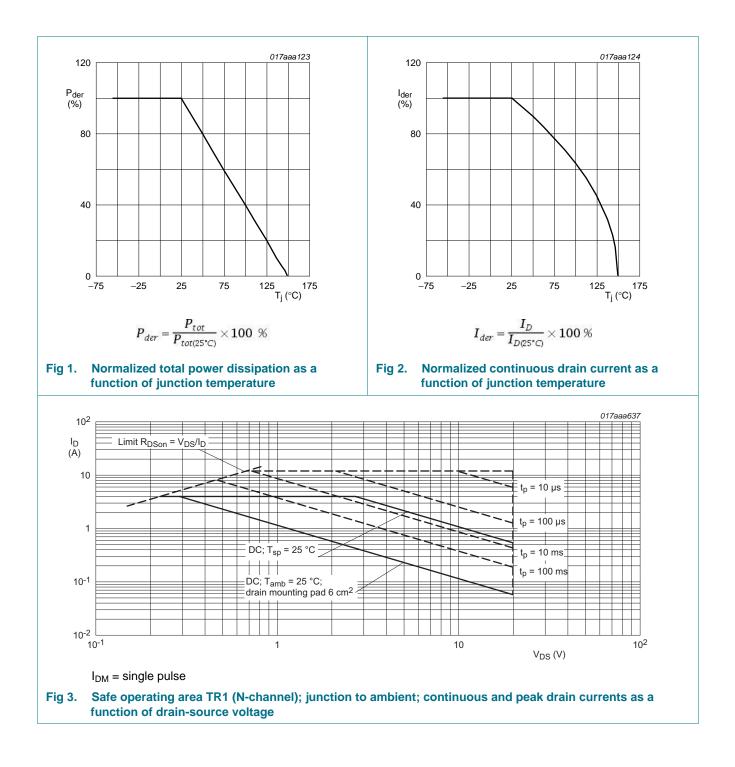
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

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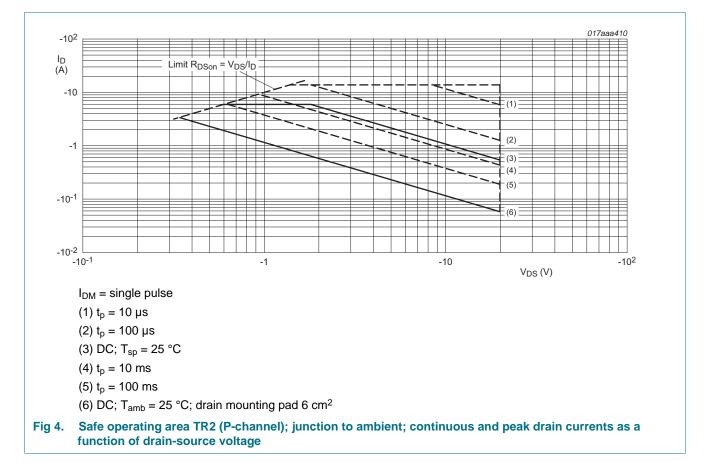
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### 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-ch	annel)						
from junction to ambient	•	in free air	in free air [1]	-	223	256	K/W
			[2]	-	93	107	K/W
	ampient	[3]	[3]	-	55	63	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	10	15	K/W
TR2 (P-ch	annel)						
R <sub>th(j-a)</sub>	thermal resistance	in free air	<u>[1]</u>	-	223	256	K/W
	from junction to		[2]	-	93	107	K/W
	ambient		[3]	-	55	63	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	10	15	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>, t  $\leq$  5 s.

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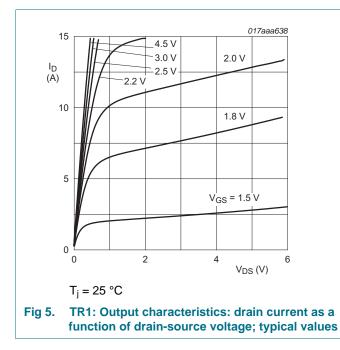
### 7. Characteristics

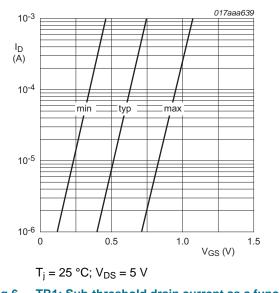
Table 7.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-cl	nannel), Static characteristic	s				
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	20	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D = 250 \ \mu A; V_{DS} = V_{GS}; T_j = 25 \ ^{\circ}C$	0.4	0.65	0.9	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 20 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μA
		$V_{DS} = 20 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	11	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 12 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
		$V_{GS} = -12 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 3 A; T <sub>j</sub> = 25 °C	-	26	34	mΩ
	resistance	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 3 A; T <sub>j</sub> = 150 °C	-	49	63	mΩ
		$V_{GS}$ = 2.5 V; I <sub>D</sub> = 1.4 A; T <sub>j</sub> = 25 °C	-	33	46	mΩ
		$V_{GS}$ = 1.8 V; I <sub>D</sub> = 1.4 A; T <sub>j</sub> = 25 °C	-	50	69	mΩ
<b>g</b> <sub>fs</sub>	transfer conductance	$V_{DS} = 5 \text{ V}; \text{ I}_{D} = 3 \text{ A}; \text{ T}_{j} = 25 \text{ °C}$	-	12	-	S
TR1 (N-cl	nannel), Dynamic characteri	stics				
Q <sub>G(tot)</sub>	total gate charge	$V_{DS} = 10 \text{ V}; \text{ I}_{D} = 3 \text{ A}; \text{ V}_{GS} = 4.5 \text{ V};$	-	14.4	21.7	nC
$Q_{GS}$	gate-source charge	T <sub>j</sub> = 25 °C	-	1.1	-	nC
$Q_{GD}$	gate-drain charge		-	1.5	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS} = 10 \text{ V}; \text{ f} = 1 \text{ MHz}; V_{GS} = 0 \text{ V};$	-	660	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	87	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	74	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 10 \text{ V}; I_D = 3 \text{ A}; V_{GS} = 4.5 \text{ V};$	-	4	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 \ ^{\circ}C$	-	15	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	40	-	ns
t <sub>f</sub>	fall time		-	16	-	ns
TR1 (N-cl	nannel), Source-drain diode	characteristics				
$V_{SD}$	source-drain voltage	$I_{S}$ = 1.2 A; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C	-	0.8	1.2	V
TR2 (P-cl	nannel), Static characteristic	S				
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = -250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-20	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 µA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-0.47	-0.65	-0.9	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = -20 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	-1	μA
		$V_{DS}$ = -20 V; $V_{GS}$ = 0 V; $T_j$ = 150 °C	-	-	-10	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 12 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	-100	nA
		$V_{GS}$ = -12 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	-100	nA

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -3.4 A; T <sub>j</sub> = 25 °C	-	55	70	mΩ
	resistance	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -3.4 A; T <sub>j</sub> = 150 °C	-	78	99	mΩ
		$V_{GS}$ = -2.5 V; $I_D$ = -3 A; $T_j$ = 25 °C	-	75	90	mΩ
		$V_{GS}$ = -1.8 V; I <sub>D</sub> = -1.5 A; T <sub>j</sub> = 25 °C	-	110	135	mΩ
<b>g</b> <sub>fs</sub>	transfer conductance	$V_{DS}$ = -10 V; I <sub>D</sub> = -3.4 A; T <sub>j</sub> = 25 °C	-	15	-	S
TR2 (P-cha	nnel), Dynamic characteri	stics				
Q <sub>G(tot)</sub>	total gate charge	$V_{DS} = -10 \text{ V}; \text{ I}_{D} = -3.4 \text{ A}; \text{ V}_{GS} = -5 \text{ V};$	-	8.1	12.2	nC
$Q_{GS}$	gate-source charge	$T_j = 25 \text{ °C}$	-	1.2	-	nC
$Q_{GD}$	gate-drain charge		-	1.5	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS} = -10 \text{ V}; \text{ f} = 1 \text{ MHz}; V_{GS} = 0 \text{ V};$	-	785	-	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 \text{ °C}$	-	63	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	53	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -10 V; $I_{D}$ = -3.4 A; $V_{GS}$ = -5 V;	-	4	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	14	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	40	-	ns
t <sub>f</sub>	fall time		-	16	-	ns
TR2 (P-cha	nnel), Source-drain diode	characteristics				
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = -1.2 A; V <sub>GS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	-0.8	-1.2	V







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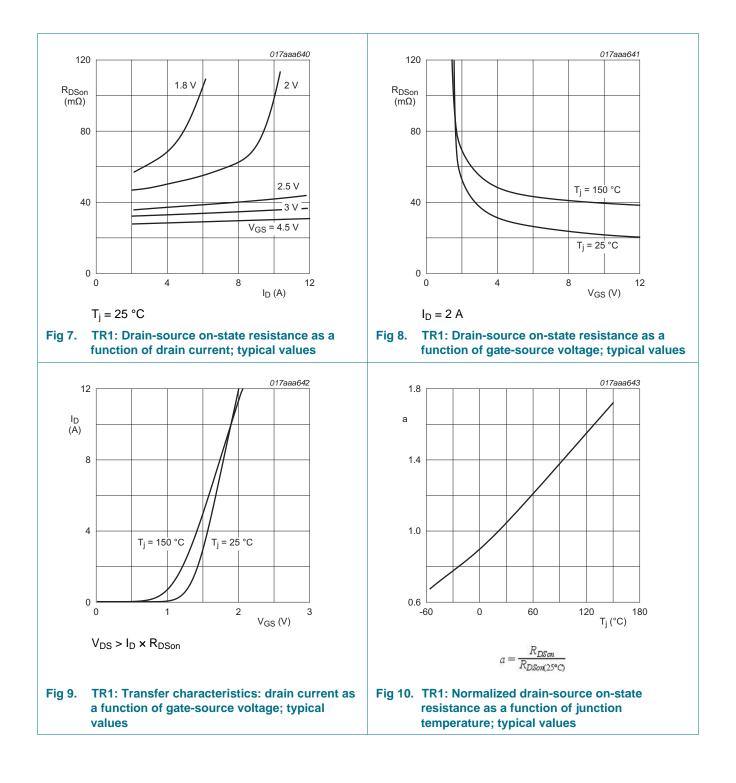
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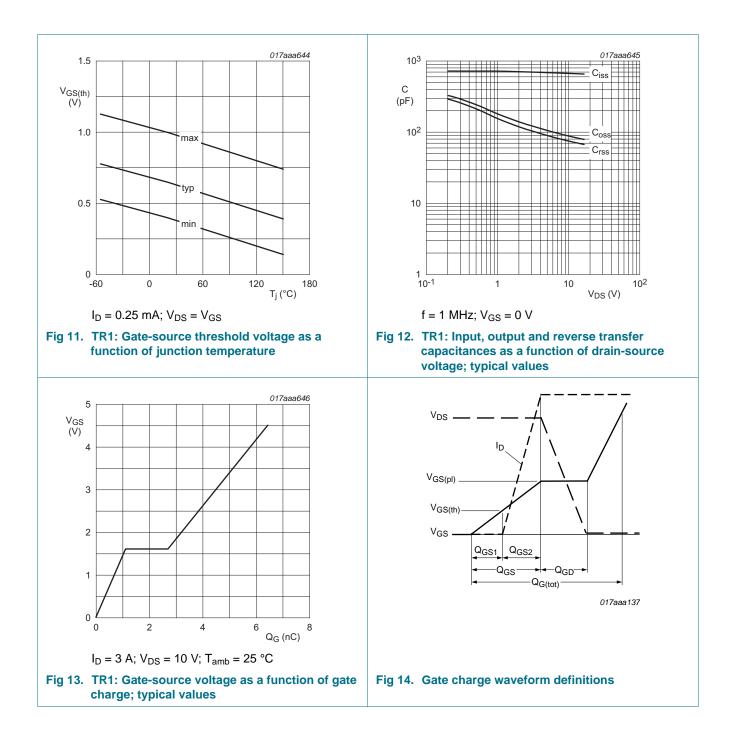
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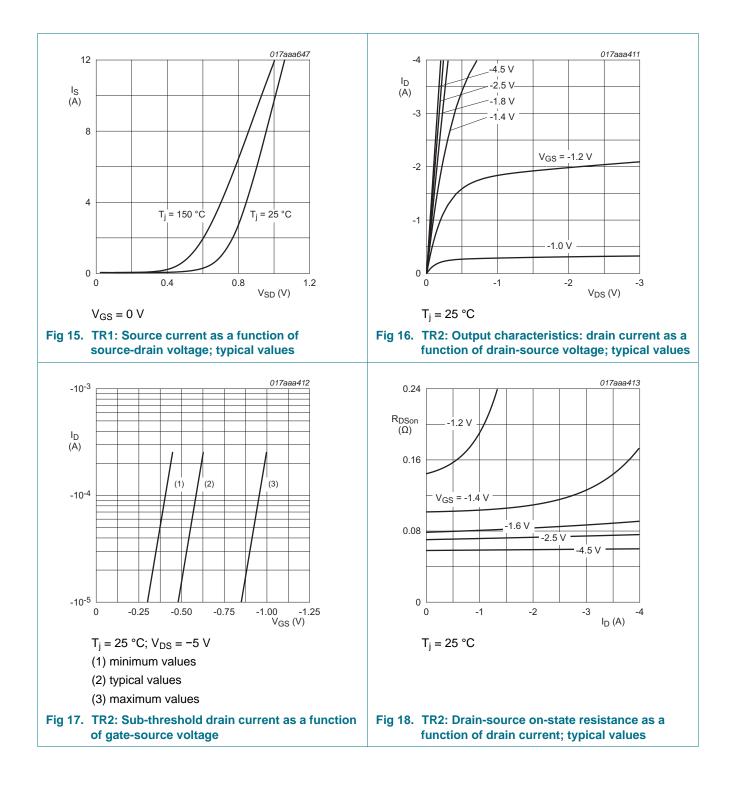
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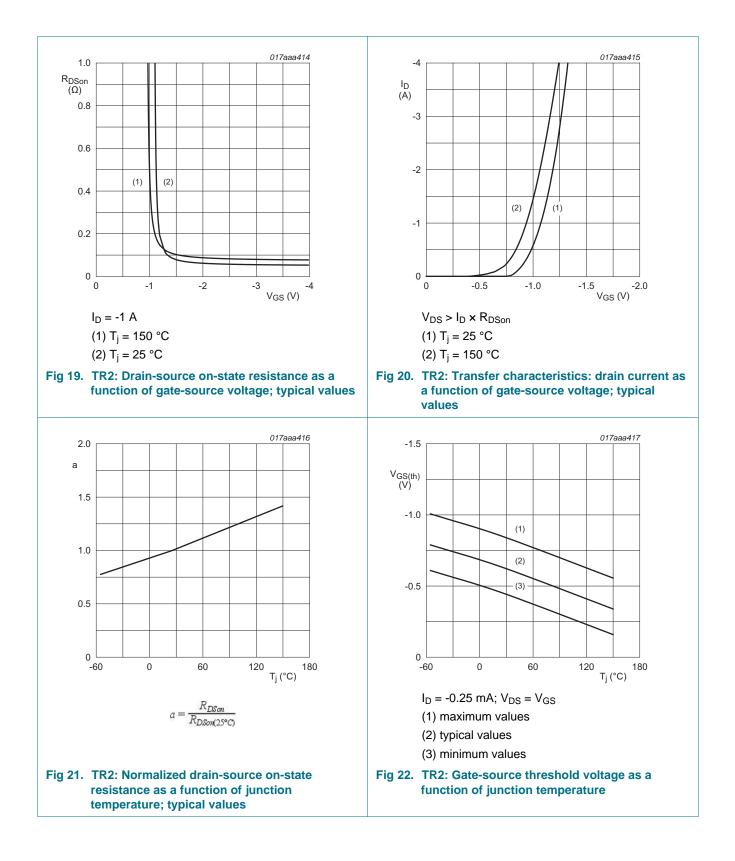


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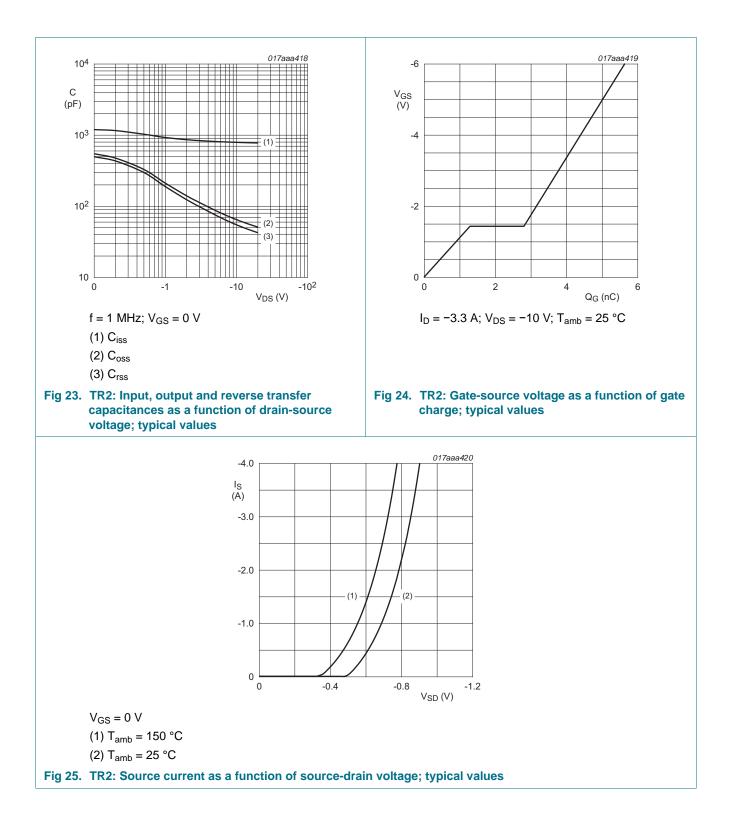


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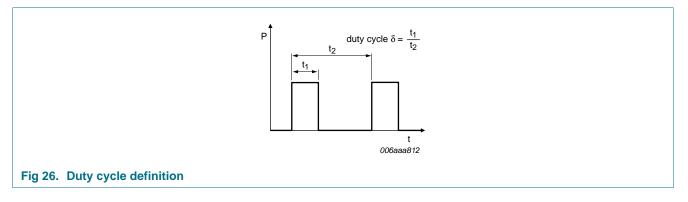
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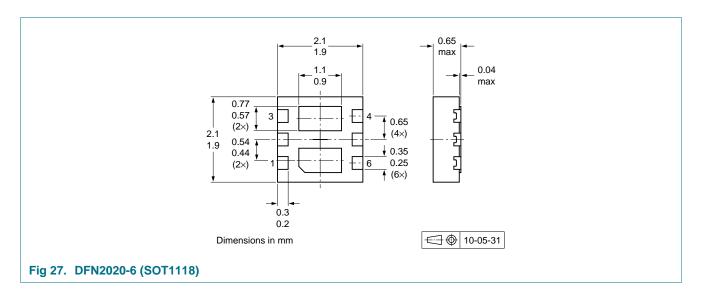
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### 8. Test information



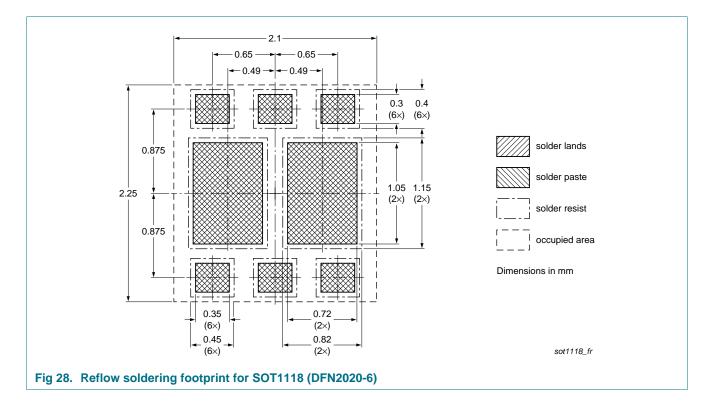
### 9. Package outline



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### **10. Soldering**



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### **11. Revision history**

Table 8.	Revision history					
Document	ID	Release date	Data sheet status	Change notice	Supersedes	
PMCPB553	0X v.1	20120626	Product data sheet	-	-	

#### 20 V, complementary Trench MOSFET

### **12. Legal information**

### **12.1 Data sheet status**

Document status[1] [2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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**Product data sheet** 

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For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 26 June 2012



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